

# FCP600N60Z / FCPF600N60Z

## N-Channel SuperFET® II MOSFET

600 V, 7.4 A, 600 mΩ



### Features

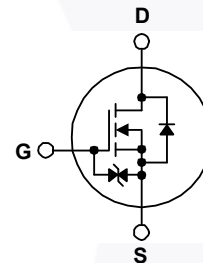
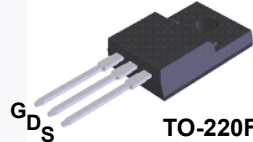
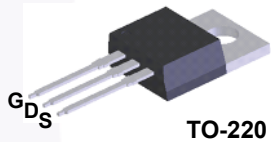
- 650 V @  $T_J = 150^\circ\text{C}$
- Typ.  $R_{DS(on)} = 510\text{ m}\Omega$
- Ultra Low Gate Charge (Typ.  $Q_g = 20\text{ nC}$ )
- Low Effective Output Capacitance (Typ.  $C_{oss(eff.)} = 74\text{ pF}$ )
- 100% Avalanche Tested
- ESD Improved Capacity
- RoHS Compliant

### Description

SuperFET® II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

### Applications

- LCD / LED / PDP TV and Monitor Lightning
- Solar Inverter
- AC-DC Power Supply



### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol         | Parameter  | FCP600N60Z                                 | FCPF600N60Z | Unit             |
|----------------|--|--|-------------|------------------|
| $V_{DSS}$      | Drain to Source Voltage  | 600  |             | V                |
| $V_{GSS}$      | Gate to Source Voltage   | - DC                                       | $\pm 20$    | V                |
|                |  | - AC ( $f > 1\text{ Hz}$ )                 | $\pm 30$    | V                |
| $I_D$          | Drain Current  | - Continuous ( $T_C = 25^\circ\text{C}$ )  | 7.4         | 7.4*             |
|                |  | - Continuous ( $T_C = 100^\circ\text{C}$ ) | 4.7         | 4.7*             |
| $I_{DM}$       | Drain Current  | - Pulsed (Note 1)                          | 22.2        | 22.2*            |
| $E_{AS}$       | Single Pulsed Avalanche Energy (Note 2)                              | 135  |             | mJ               |
| $I_{AR}$       | Avalanche Current (Note 1)   | 1.5  |             | A                |
| $E_{AR}$       | Repetitive Avalanche Energy (Note 1)                                 | 0.89                                       |             | mJ               |
| dv/dt          | MOSFET dv/dt   | 100  |             | V/ns             |
|                | Peak Diode Recovery dv/dt (Note 3)                                   | 20   |             |                  |
| $P_D$          | Power Dissipation  | ( $T_C = 25^\circ\text{C}$ )               | 89          | 28               |
|                |  | - Derate Above $25^\circ\text{C}$          | 0.71        | 0.22             |
| $T_J, T_{STG}$ | Operating and Storage Temperature Range                              | -55 to +150                                |             | $^\circ\text{C}$ |
| $T_L$          | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds | 300  |             | $^\circ\text{C}$ |

\*Drain current limited by maximum junction temperature.

### Thermal Characteristics

| Symbol          | Parameter                                     | FCP600N60Z | FCPF600N60Z | Unit                      |
|-----------------|---|------------|-------------|---------------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max.    | 1.4        | 4.5         | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 62.5       | 62.5        |                           |

## Package Marking and Ordering Information

| Part Number | Top Mark    | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|-------------|---------|----------------|-----------|------------|----------|
| FCP600N60Z  | FCP600N60Z  | TO-220  | Tube           | N/A       | N/A        | 50 units |
| FCPF600N60Z | FCPF600N60Z | TO-220F | Tube           | N/A       | N/A        | 50 units |

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------|-----------|-----------------|------|------|------|------|
|--------|-----------|-----------------|------|------|------|------|

### Off Characteristics

|                                |   |  |     |      |          |                           |
|--------------------------------|---|--|-----|------|----------|---------------------------|
| $BV_{DSS}$                     | Drain to Source Breakdown Voltage           | $V_{GS} = 0\text{ V}, I_D = 10\text{ mA}, T_J = 25^\circ\text{C}$  | 600 | -    | -        | V                         |
|                                |   | $V_{GS} = 0\text{ V}, I_D = 10\text{ mA}, T_J = 150^\circ\text{C}$ | 650 | -    | -        |                           |
| $\Delta BV_{DSS} / \Delta T_J$ | Breakdown Voltage Temperature Coefficient   | $I_D = 10\text{ mA}$ , Referenced to $25^\circ\text{C}$            | -   | 0.67 | -        | $\text{V}/^\circ\text{C}$ |
| $BV_{DS}$                      | Drain to Source Avalanche Breakdown Voltage | $V_{GS} = 0\text{ V}, I_D = 7.4\text{ A}$                          | -   | 700  | -        | V                         |
| $I_{DSS}$                      | Zero Gate Voltage Drain Current             | $V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$                       | -   | -    | 1        | $\mu\text{A}$             |
|                                |   | $V_{DS} = 480\text{ V}, T_C = 125^\circ\text{C}$                   | -   | 1.32 | -        |                           |
| $I_{GSS}$                      | Gate to Body Leakage Current                | $V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$                    | -   | -    | $\pm 10$ | $\mu\text{A}$             |

### On Characteristics

|              |                                      |   |     |      |     |          |
|--------------|--------------------------------------|---|-----|------|-----|----------|
| $V_{GS(th)}$ | Gate Threshold Voltage               | $V_{GS} = V_{DS}, I_D = 250\text{ }\mu\text{A}$ | 2.5 | -    | 3.5 | V        |
| $R_{DS(on)}$ | Static Drain to Source On Resistance | $V_{GS} = 10\text{ V}, I_D = 3.7\text{ A}$      | -   | 0.51 | 0.6 | $\Omega$ |
| $g_{FS}$     | Forward Transconductance             | $V_{DS} = 20\text{ V}, I_D = 3.7\text{ A}$      | -   | 6.7  | -   | S        |

### Dynamic Characteristics

|                 |                               |   |          |      |      |          |
|-----------------|-------------------------------|---|----------|------|------|----------|
| $C_{iss}$       | Input Capacitance             | $V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$     | -        | 840  | 1120 | pF       |
| $C_{oss}$       | Output Capacitance            |   | -        | 630  | 840  | pF       |
| $C_{rss}$       | Reverse Transfer Capacitance  |   | -        | 30   | 45   | pF       |
| $C_{oss}$       | Output Capacitance            | $V_{DS} = 380\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$    | -        | 16.5 | -    | pF       |
| $C_{oss(eff.)}$ | Effective Output Capacitance  | $V_{DS} = 0\text{ V to } 480\text{ V}, V_{GS} = 0\text{ V}$       | -        | 74   | -    | pF       |
| $Q_{g(tot)}$    | Total Gate Charge at 10V      | $V_{DS} = 380\text{ V}, I_D = 3.7\text{ A}, V_{GS} = 10\text{ V}$ | -        | 20   | 26   | nC       |
| $Q_{gs}$        | Gate to Source Gate Charge    |   | -        | 3.4  | -    | nC       |
| $Q_{gd}$        | Gate to Drain "Miller" Charge |   | (Note 4) | -    | 7.5  | -        |
| ESR             | Equivalent Series Resistance  | $f = 1\text{ MHz}$  | -        | 2.89 | -    | $\Omega$ |

### Switching Characteristics

|              |                     |  |          |    |    |    |
|--------------|---------------------|--|----------|----|----|----|
| $t_{d(on)}$  | Turn-On Delay Time  | $V_{DD} = 380\text{ V}, I_D = 3.7\text{ A}, V_{GS} = 10\text{ V}, R_G = 4.7\text{ }\Omega$ | -        | 13 | 36 | ns |
| $t_r$        | Turn-On Rise Time   |  | -        | 7  | 24 | ns |
| $t_{d(off)}$ | Turn-Off Delay Time |  | -        | 39 | 88 | ns |
| $t_f$        | Turn-Off Fall Time  |  | (Note 4) | -  | 9  | 28 |

### Drain-Source Diode Characteristics

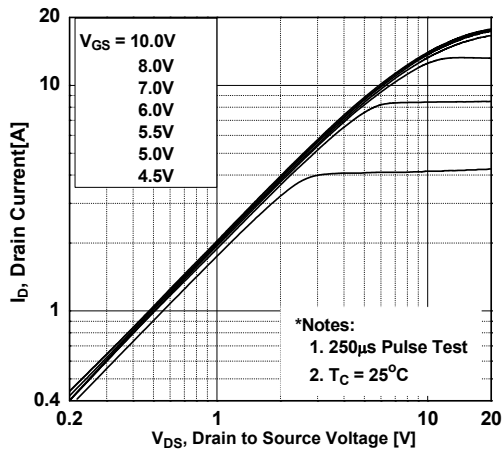
|          |  |  |   |      |     |               |
|----------|--|--|---|------|-----|---------------|
| $I_S$    | Maximum Continuous Drain to Source Diode Forward Current | -  | - | 7.4  | A   |               |
| $I_{SM}$ | Maximum Pulsed Drain to Source Diode Forward Current     | -  | - | 22.2 | A   |               |
| $V_{SD}$ | Drain to Source Diode Forward Voltage                    | $V_{GS} = 0\text{ V}, I_{SD} = 3.7\text{ A}$                                     | - | -    | 1.2 | V             |
| $t_{rr}$ | Reverse Recovery Time                                    | $V_{GS} = 0\text{ V}, I_{SD} = 3.7\text{ A}, di_F/dt = 100\text{ A}/\mu\text{s}$ | - | 200  | -   | ns            |
| $Q_{rr}$ | Reverse Recovery Charge                                  |  | - | 2.3  | -   | $\mu\text{C}$ |

#### Notes:

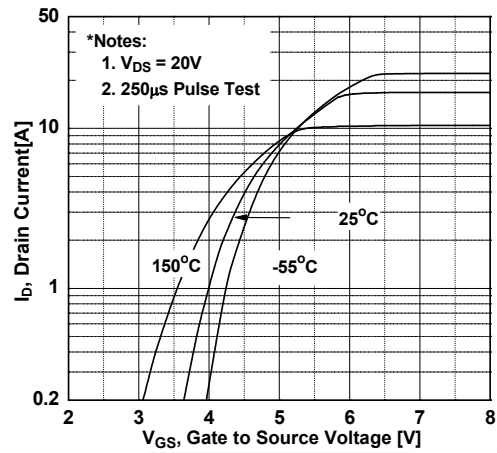
1. Repetitive rating: pulse-width limited by maximum junction temperature.
2.  $I_{AS} = 1.5\text{ A}, V_{DD} = 50\text{ V}, R_G = 25\text{ }\Omega$ , starting  $T_J = 25^\circ\text{C}$ .
3.  $I_{SD} \leq 3.7\text{ A}, di/dt \leq 200\text{ A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$ , starting  $T_J = 25^\circ\text{C}$ .
4. Essentially independent of operating temperature typical characteristics.

## Typical Performance Characteristics

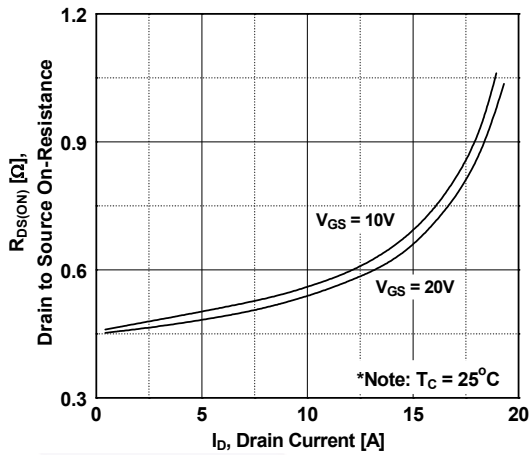
**Figure 1. On-Region Characteristics**



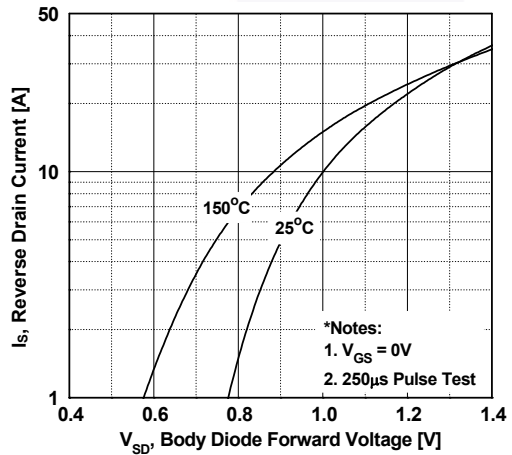
**Figure 2. Transfer Characteristics**



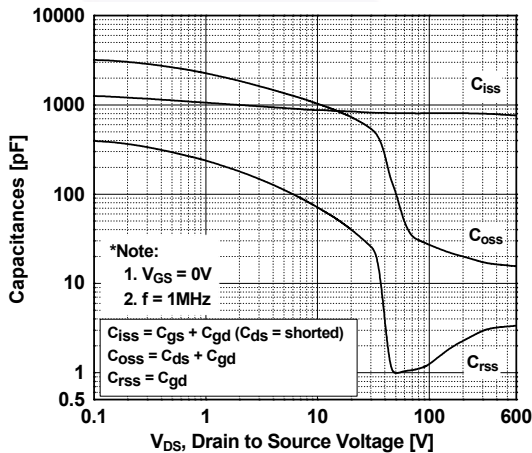
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



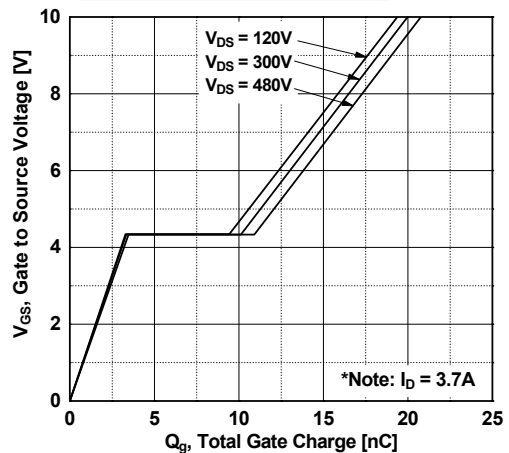
**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**



**Figure 5. Capacitance Characteristics**

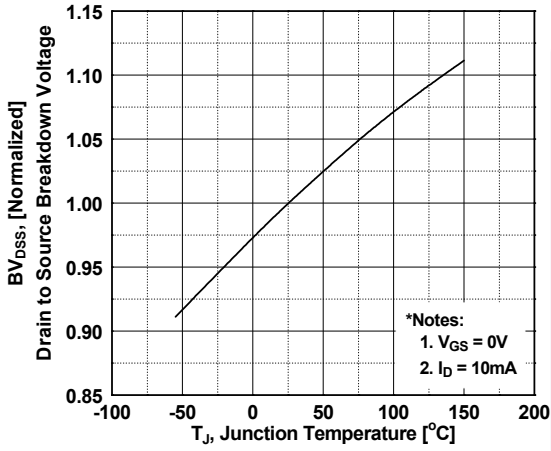


**Figure 6. Gate Charge Characteristics**

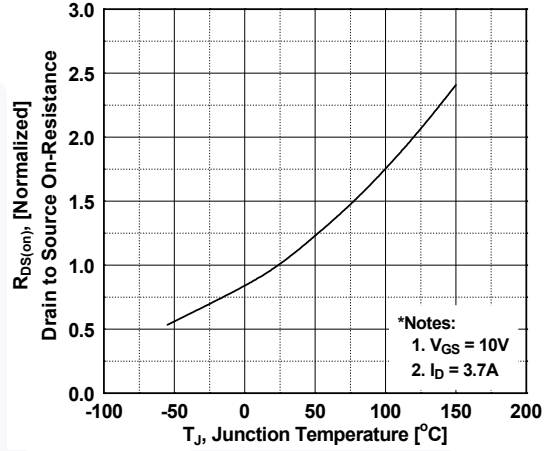


**Typical Performance Characteristics** (Continued)

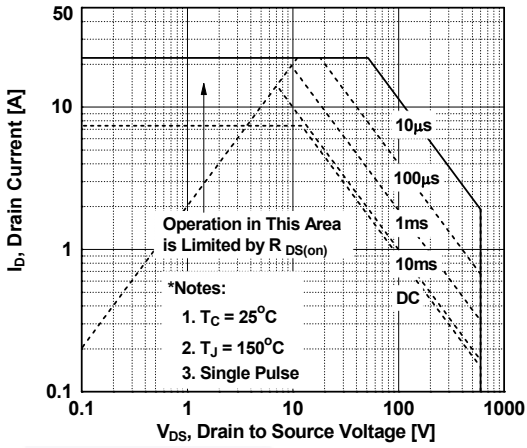
**Figure 7. Breakdown Voltage Variation vs. Temperature**



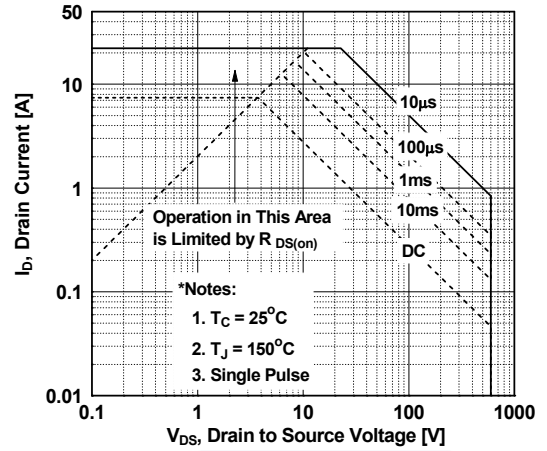
**Figure 8. On-Resistance Variation vs. Temperature**



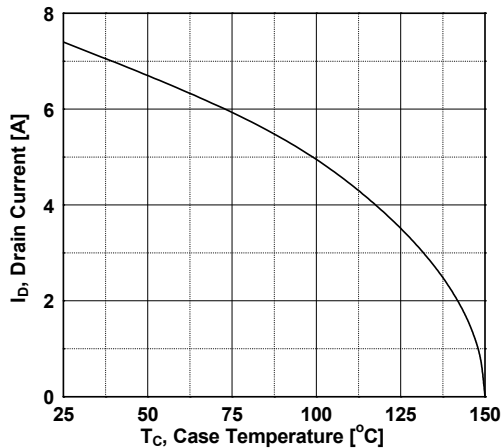
**Figure 9. Maximum Safe Operating Area for FCP600N60Z**



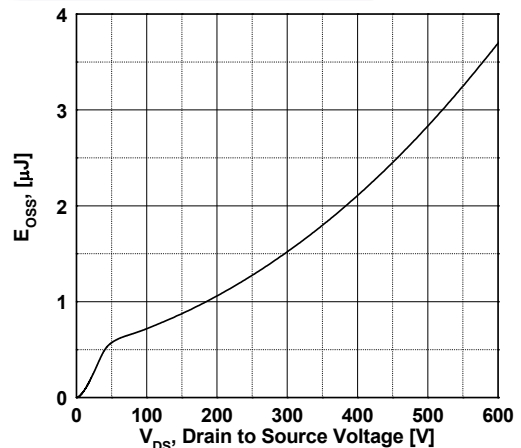
**Figure 10. Maximum Safe Operating Area for FCPF600N60Z**



**Figure 11. Maximum Drain Current vs. Case Temperature**



**Figure 12. E\_oss vs. Drain to Source Voltage**



Typical Performance Characteristics (Continued)

Figure 13. Transient Thermal Response Curve for FCP600N60Z

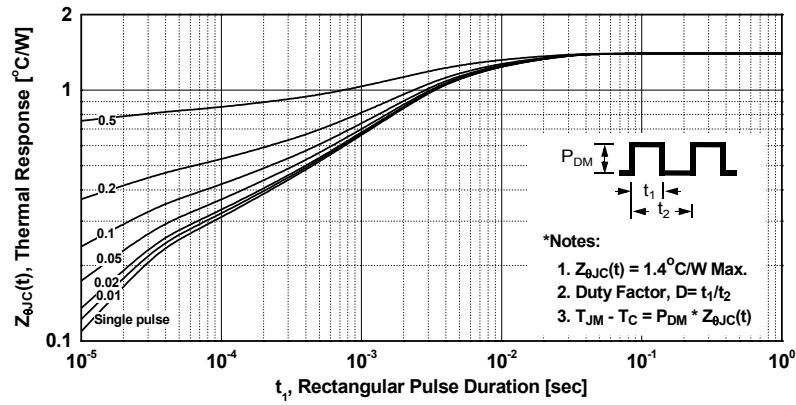
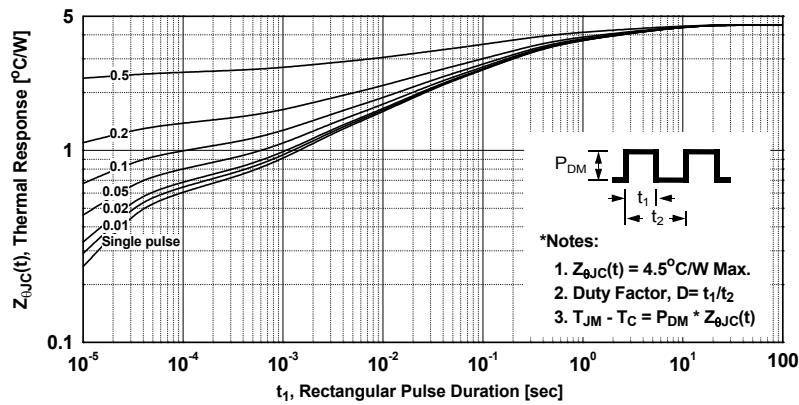


Figure 14. Transient Thermal Response Curve for FCPF600N60Z



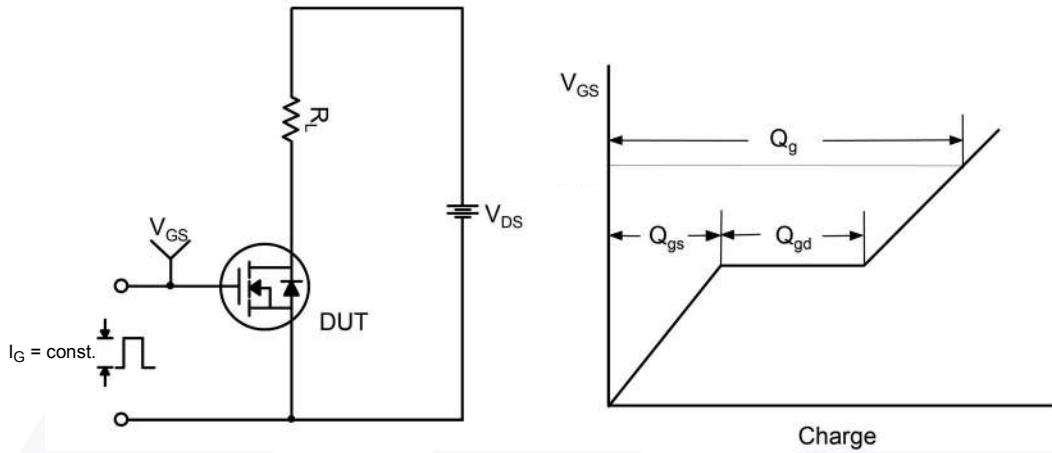


Figure 15. Gate Charge Test Circuit & Waveform

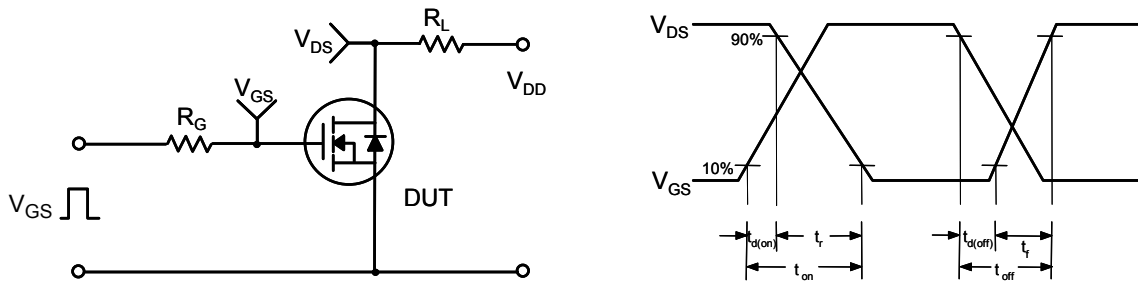


Figure 16. Resistive Switching Test Circuit & Waveforms

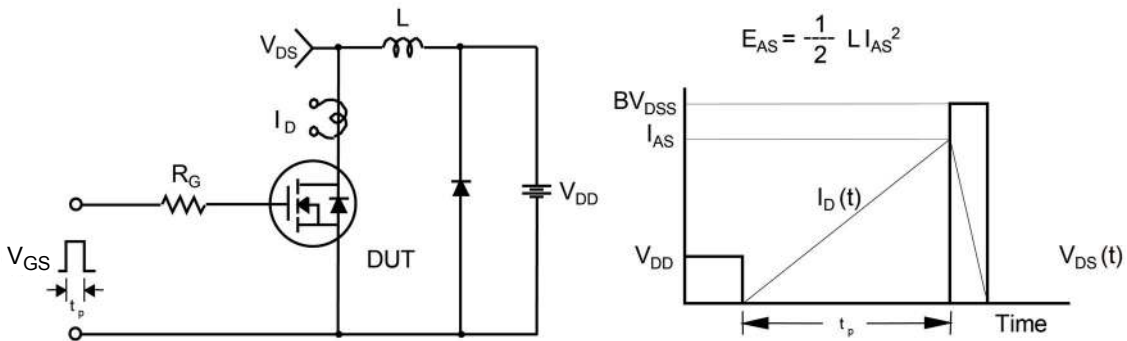


Figure 17. Unclamped Inductive Switching Test Circuit & Waveforms

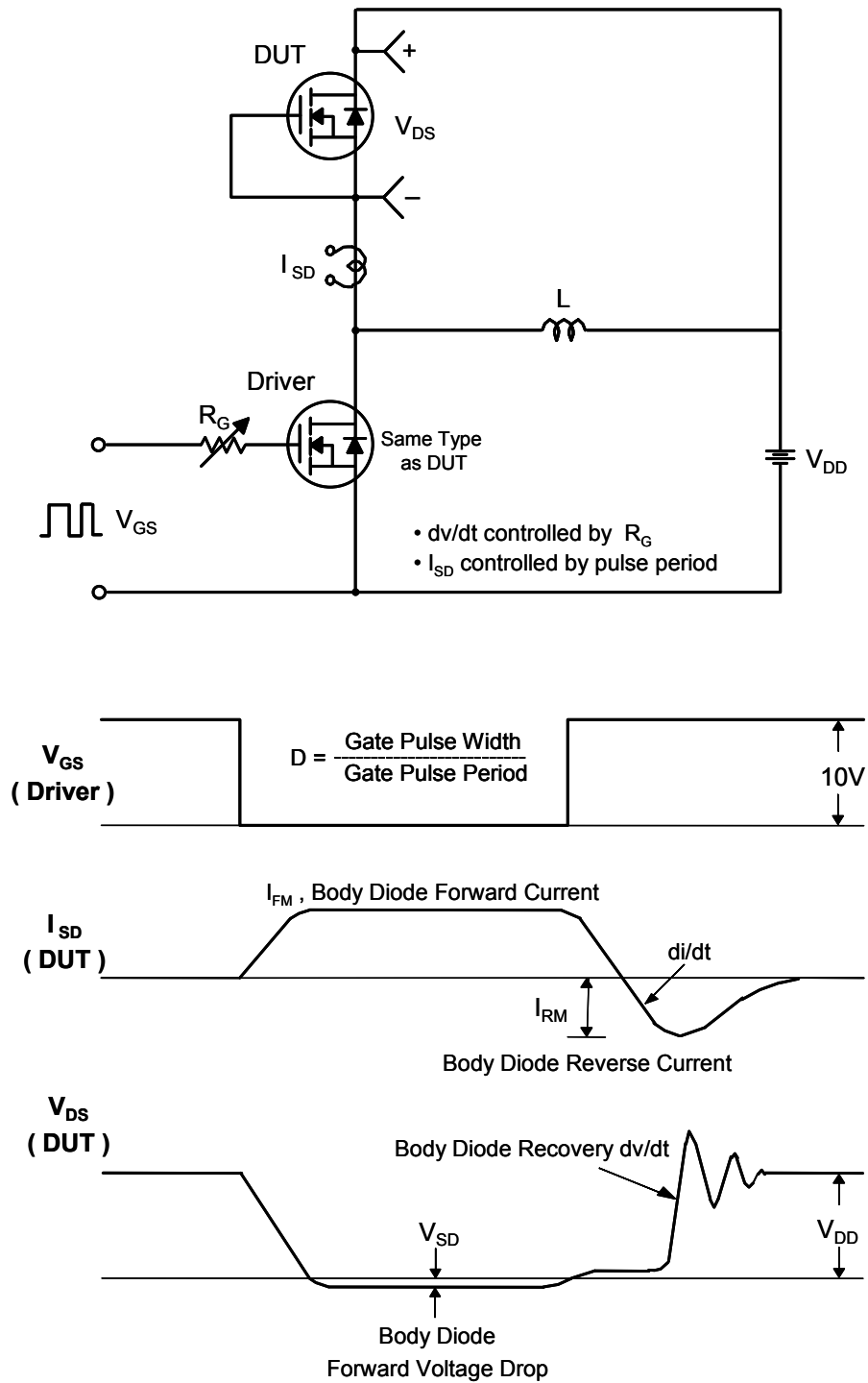
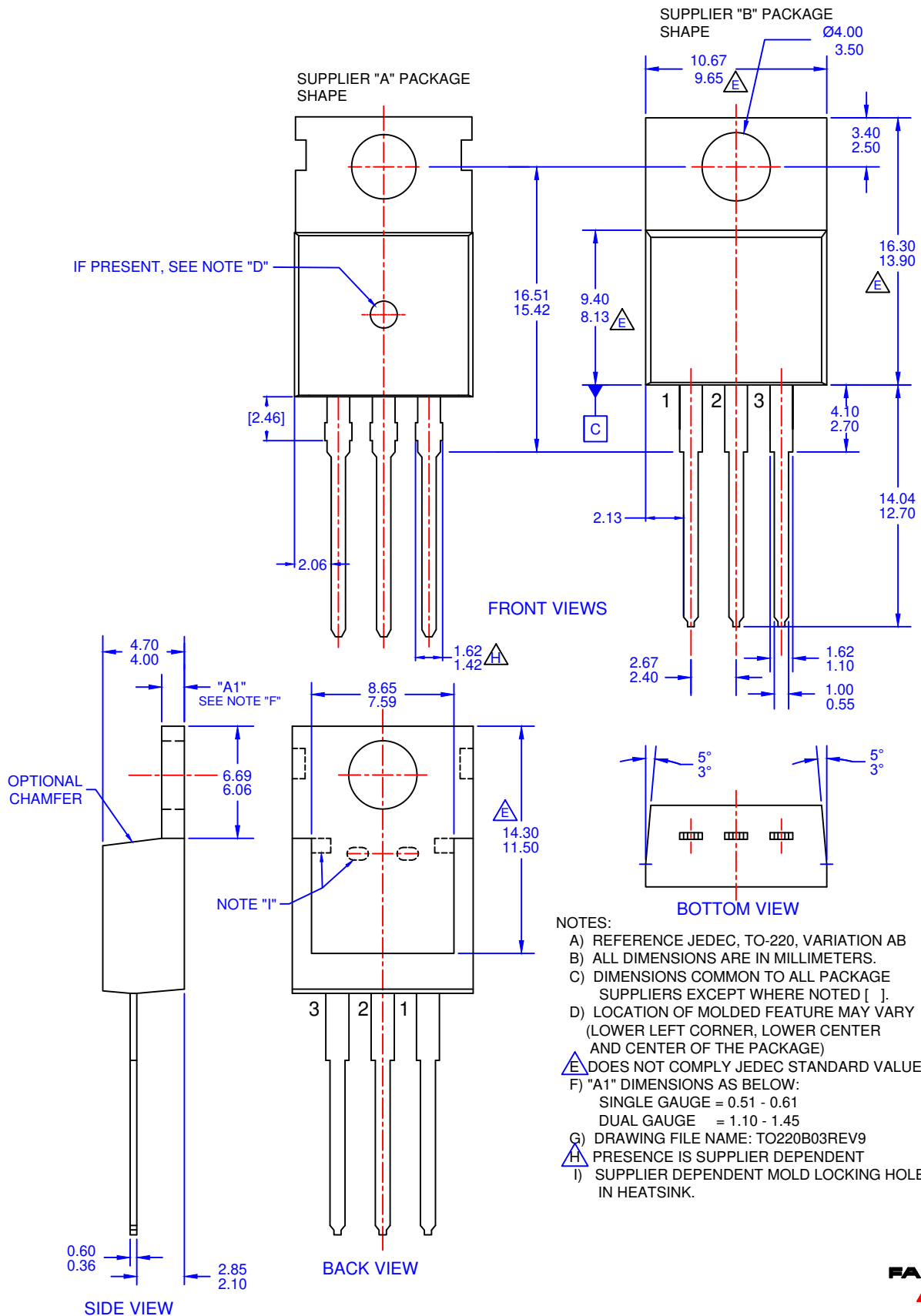


Figure 18. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms



- NOTES:
- A) REFERENCE JEDEC, TO-220, VARIATION AB
  - B) ALL DIMENSIONS ARE IN MILLIMETERS.
  - C) DIMENSIONS COMMON TO ALL PACKAGE SUPPLIERS EXCEPT WHERE NOTED [ ].
  - D) LOCATION OF MOLDED FEATURE MAY VARY (LOWER LEFT CORNER, LOWER CENTER AND CENTER OF THE PACKAGE)
  - E) DOES NOT COMPLY JEDEC STANDARD VALUE.
  - F) "A1" DIMENSIONS AS BELOW:  
 SINGLE GAUGE = 0.51 - 0.61  
 DUAL GAUGE = 1.10 - 1.45
  - G) DRAWING FILE NAME: TO220B03REV9
  - H) PRESENCE IS SUPPLIER DEPENDENT
  - I) SUPPLIER DEPENDENT MOLD LOCKING HOLES IN HEATSINK.












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| FastvCore™  | MVN®   | SuperSOT™-8   | Xsens™  |
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